STL140N4F7AG

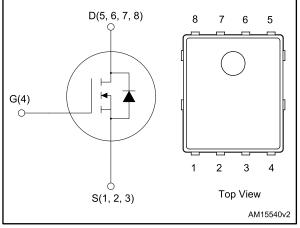
Datasheet - production data



Automotive-grade N-channel 40 V, 2.1 mΩ typ., 120 A STripFET™ F7 Power MOSFET in a PowerFLAT™ 5x6 package

PowerFLAT™ 5x6

Figure 1: Internal schematic diagram



Features

Order code	VDS	R _{DS(on)} max	ΙD
STL140N4F7AG	40 V	2.5 mΩ	120 A

- AEC-Q101 qualified
- Among the lowest R_{DS(on)} on the market
- Excellent FoM (figure of merit)
- Low Crss/Ciss ratio for EMI immunity
- High avalanche ruggedness
- Wettable flank package

Applications

• Switching applications

Description

This N-channel Power MOSFET utilizes STripFET™ F7 technology with an enhanced trench gate structure that results in very low on-state resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.

Table 1: Device summary

Order code Mar		Marking	Package	Packaging	
	STL140N4F7AG	140N4F7	PowerFLAT [™] 5x6	Tape and reel	l

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This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vds	Drain-source voltage	40	V
V _{GS}	Gate-source voltage	±20	V
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25 °C	120	А
ID ⁽¹⁾	Drain current (continuous) at T _c = 100 °C	120	А
I _{DM} ⁽²⁾	Drain current (pulsed)	480	А
P _{TOT} ⁽¹⁾	Total dissipation at $T_c = 25 \ ^{\circ}C$	111	W
I _{AV}	Avalanche current, repetitive (pulse width limited by maximum junction temperature)	16	A
Eas	Single pulse avalanche energy (Tj= 25 °C, ID= IAV, VDD= 25 V) 260		mJ
T _{stg}	T _{stg} Storage temperature range		°C
Tj	Operating junction temperature range	-55 to 175	C

Notes:

 $^{(1)}\mbox{Drain current}$ is limited by package, the current capability of the silicon is 178 A at 25 °C.

 $^{(2)}\mbox{Pulse}$ width is limited by safe operating area.

Table 3: Thermal data

Symbol	Parameter	Value	Unit
Rthj-pcb ⁽¹⁾	Thermal resistance junction-pcb max.	31.3	°C/W
R _{thj-case}	Thermal resistance junction-case max.	1.35	°C/W

Notes:

 $^{(1)}\!When$ mounted on FR-4 board of 1 inch², 2oz Cu, t < 10 s



2 Electrical characteristics

(T_c = 25 °C unless otherwise specified).

Table 4: On /off states						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	40			V
IDSS	Zero gate voltage drain current	V _{GS} = 0 V, V _{DS} = 40 V			1	μA
I _{GSS}	Gate-body leakage current	$V_{GS}=20~V,~V_{DS}=0~V$			100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2		4	V
R _{DS(on)}	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, I_D = 16 \text{ A}$		2.1	2.5	mΩ

	Table 5: Dynamic						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
Ciss	Input capacitance		-	2300	-	pF	
Coss	Output capacitance	$V_{DS} = 25 V, f = 1 MHz,$ $V_{GS} = 0 V$	-	786	-	pF	
Crss	Reverse transfer capacitance	VGS- 0 V	-	43	-	pF	
Qg	Total gate charge	$V_{DD} = 20 V, I_D = 32 A,$	-	29	-	nC	
Qgs	Gate-source charge	V _{GS} = 0 to 10 V	-	13	-	nC	
Q_{gd}	Gate-drain charge	(see Figure 14: "Test circuit for gate charge behavior")	-	5.6	-	nC	

Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 20 \text{ V}, \text{ I}_{D} = 16 \text{ A},$	-	14	-	ns
tr	Rise time	$R_{G} = 4.7 \Omega, V_{GS} = 10 V$	-	6.6	-	ns
t _{d(off)}	Turn-off delay time	(see Figure 13: "Test circuit for resistive load switching	-	19	-	ns
t _f	Fall time	times" and Figure 18: "Switching time waveform")	-	5.7	-	ns

Table 7: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{SD} ⁽¹⁾	Forward on voltage	I _{SD} = 32 A, V _{GS} = 0 V	-		1.2	V
trr	Reverse recovery time	I _D = 32 A, di/dt = 100 A/µs,	-	55		ns
Qrr	Reverse recovery charge	V _{DD} = 32 V	-	67		nC
Irrm	Reverse recovery current	(see Figure 15: "Test circuit for inductive load switching and diode recovery times")	-	2.4		A

Notes:

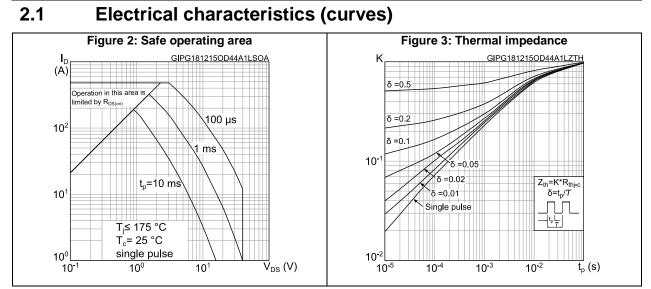
 $^{(1)}\text{Pulsed:}$ pulse duration = 300 $\mu\text{s},$ duty cycle 1.5%

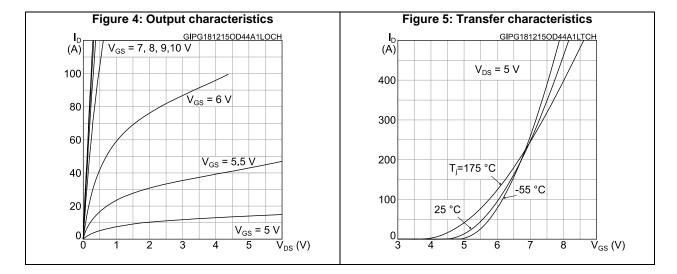


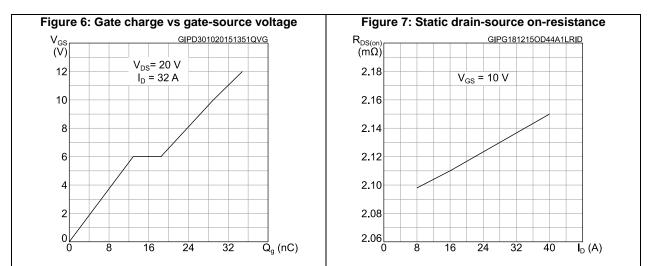


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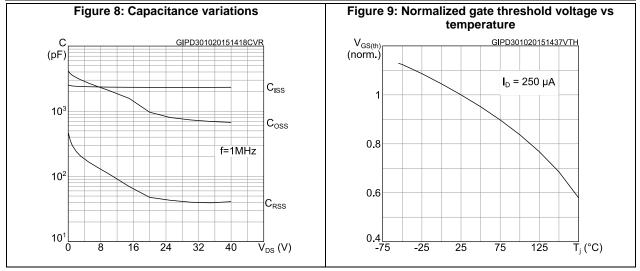


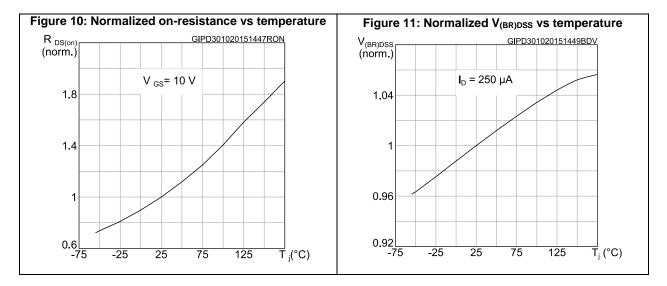


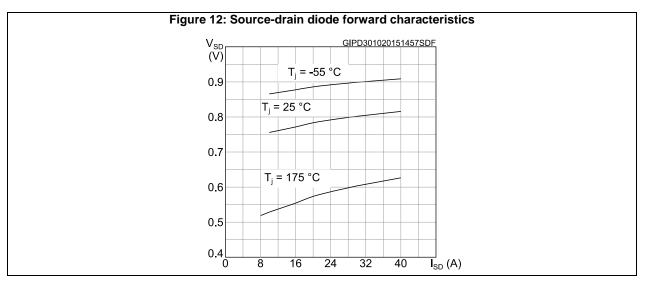
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Electrical characteristics

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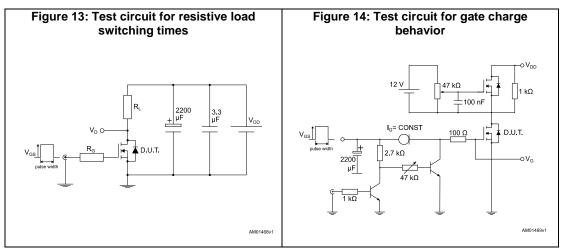


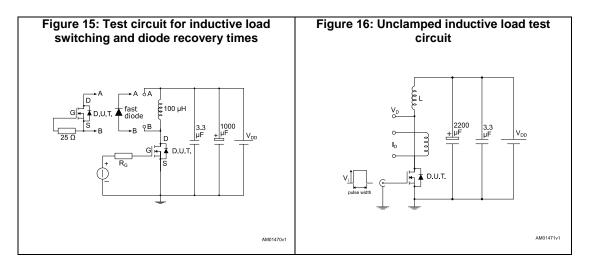


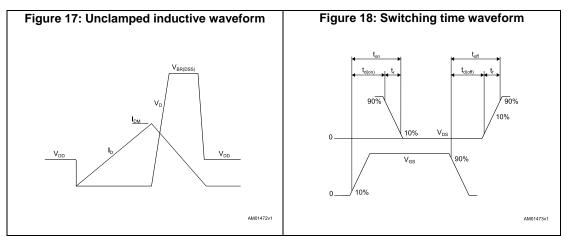
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3 Test circuits









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4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 PowerFLAT[™] 5x6 package information

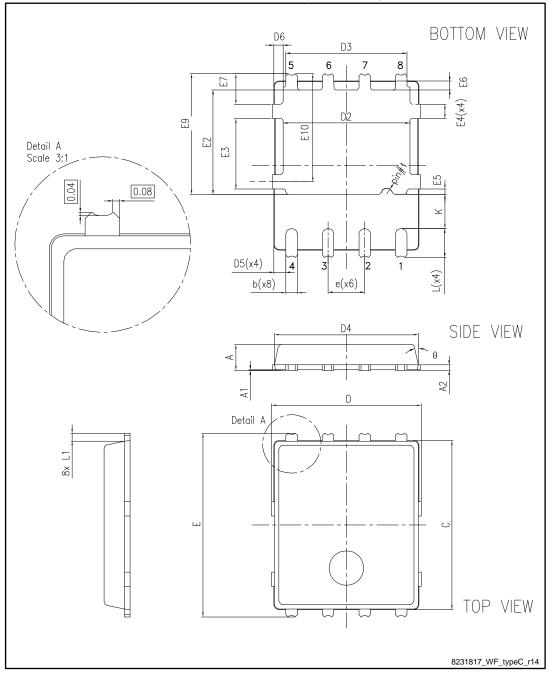


Figure 19: PowerFLAT™ 5x6 WF type C package outline

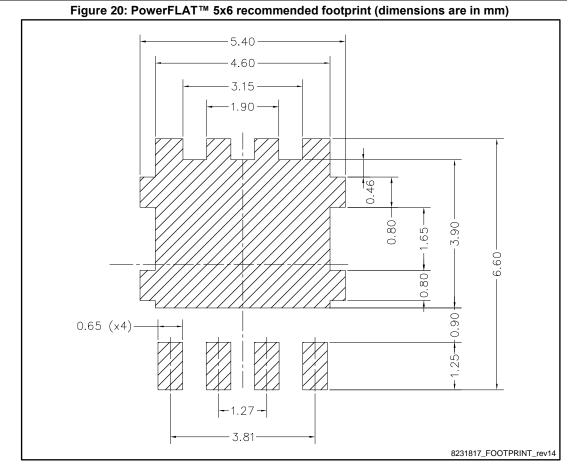
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'AG			Package informatio
Т	able 8: PowerFLAT™ 5x6	WF type C mechanical o	lata
Dim.		mm	
Dim.	Min.	Тур.	Max.
А	0.80		1.00
A1	0.02		0.05
A2		0.25	
b	0.30		0.50
С	5.80	6.00	6.10
D	5.00	5.20	5.40
D2	4.15		4.45
D3	4.05	4.20	4.35
D4	4.80	5.00	5.10
D5	0.25	0.40	0.55
D6	0.15	0.30	0.45
е		1.27	
E	6.20	6.40	6.60
E2	3.50		3.70
E3	2.35		2.55
E4	0.40		0.60
E5	0.08		0.28
E6	0.20	0.325	0.45
E7	0.85	1.00	1.15
E9	4.00	4.20	4.40
E10	3.55	3.70	3.85
К	1.05		1.35
L	0.90	1.00	1.10
L1	0.175	0.275	0.375
θ	0°		12°



Package information

STL140N4F7AG





4.2 PowerFLAT[™] 5x6 packing information

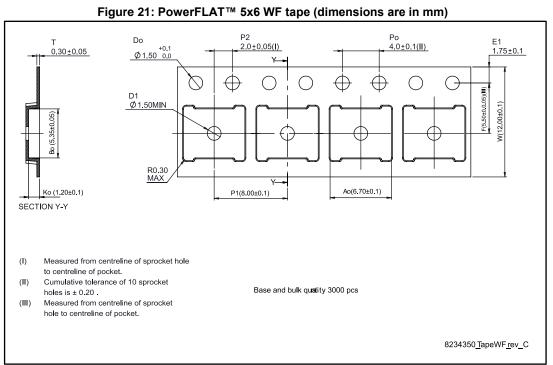
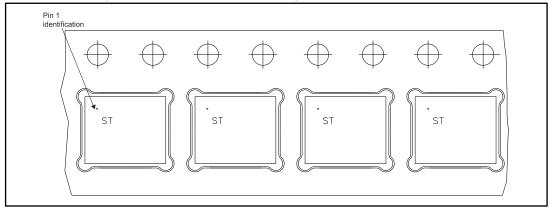


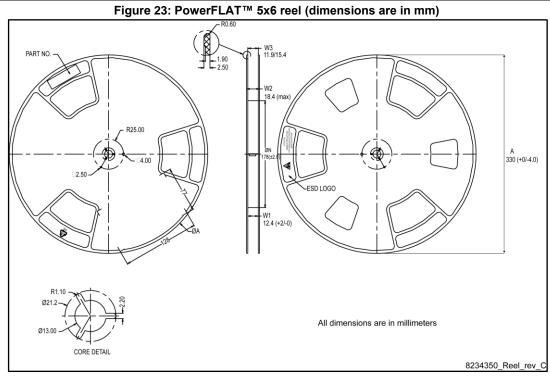
Figure 22: PowerFLAT™ 5x6 package orientation in carrier tape





Package information

STL140N4F7AG





5 Revision history

Table 9: Document revision history

Date	Revision	Changes
14-Jan-2015	1	First release
15-Feb-2017	2	Updated package silhouette on cover page and <i>Section 4: "Package information"</i> . Updated <i>Table 2: "Absolute maximum ratings"</i> . Minor text changes



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